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		epartment of Commerce nt and Trademark Office		Atty. Dock FIS920030			Application No. 10/605,906				
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BY APPLICANT (Use several sheets if necessary)				Filing Date	2	Group					
,,				11/05/2003			2813				
U.S. PATENT DOCUMENTS											
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME		CLASS	SUBCLASS	FILING DATE IF APPROPRIATE				
JWB,	US 2002/0063292 A1	5-30-2002	Armstrong et al.		—						
I.W.Q.	US 2003/0032261 A1	2-13-2003	Yeh et al.			 					
IWI	US 2003/0040158 A1	2-27-2003	Saitoh		—						
2/W.L.	US 2004/0238914 A1	12-2-2004	Deshpande et al.								
2012	US 2004/0262784 A1	12-30-2004	Doris et al.								
I/) I.	US 2005/0040460 A1	2-24-2005	Chidambarrao et al.								
INQ.	US 2005/0082634 A1	4-21-2005	Doris et al.								
&WQ.	US 2005/0093030 A1	5-5-2005	Doris et al.								
IWI,	US 2005/0098829 A1	5-12-2005	Doris et al.								
I.W.J.	US 2005/0106799 A1	5-19-2005	Doris e	Doris et al.			-				
	US 2005/0145954 A1	7-7-2005	Zhu et al.								
IWI.	US 2005/0148146 A1	7-7-2005	Doris et al.				-				
INI.	US 2005/0194699 A1	9-8-2005	Belyansky et al.		—	<u> </u>	-				
I Wil.	US 2005/0236668 A1	10-27-2005	Zhu et al.								
IWI.	US 2005/0245017 A I	11-3-2005	Belyansky et al.		—		·				
IWI.	US 2005/0280051 AI	12-22-2005	Chidambarrao et al.								
INIX.	US 2005/0282325 A1	12-22-2005	Belyansky et al.								
INI.	US 2006/0027868 A1	2-9-2006	Doris et al.			——					
I/W.I.	US 2006/0057787 A1	3-16-2006	Doris et al.		—						
INI.	US 2006/0060925 A1	3-23-2006	Doris et al.								
INJ.	6,483,171	11-19-2002	Forbes	Forbes et al.							
IW. 2.	6,831,292	12-14-2004	Currie e	et al.							
INI.	6,717,216	4-6-2004	Doris et	Poris et al.							
11,2,2,	6,825,529	11-30-2004	Chidam	Chidambarrao et al.							
IWI.	7,015,082	3-21-2006	Doris et	Doris et al.			-				
IWL	6,974,981	12-13-2005	Chidam	Chidambarrao et al.							
INA.	6,977,194	12-20-2005	Belyansky et al.								
FOREIGN PATENT DOCUMENTS											
00.0	DOCUMENT NUMBER	DATE	COU	NTRY	CLASS	SUBCLASS	TRANSLATION YES NO				
XIV.X.	JP 64-76755	3-22-1989	Japan				X				
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)											
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EXAMINER SUMMIN, SMADO DATE CONSIDERED Ayoust 1, 2006											
*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in											
conformance and not considered. Include copy of this form with next communication to applicant.											

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FORM PTO-1449		U.S. Department of Commerce					Application No.						
	Patent	Patent and Trademark Office					10/605,906						
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary) Filing Date . Group													
		Filing Date / Group											
				11/05/2003 2813									
U.S. PATENT DOCUMENTS													
EXAMINER		DATE			23	1		FILING DATE					
INITIAL	DOCUMENT NUMBER	TATE DOCU	NAME CLASS SUBCLASS IF APPROPRIATE										
FOREIGN PATENT DOCUMENTS TRANSLATION													
	DOCUMENT NUMBER	DATE	COU	NTRY	CLASS SUBC		CLASS						
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)													
SN.S.		G. Zhang, et al., "A New 'Mixed-Mode' Reliability Degradation Mechanism in Advanced Si and SiGe Bipolar Transistors." IEEE Transactions on Electron Devices, vol. 49, no. 12, December 2002, pp. 2151-56.											
SiWiZ,		H.S. Momose, et al., "Temperature Dependence of Emitter-Base Reverse Stress Degradation and its Mechanism Analyzed by MOS Structures." 1989 IEEE, Paper 6.2, pp. 140-143.											
LNL,		C.J. Huang, et al., "Temperature Dependence and Post-Stress Recovery of Hot Electron Degradation Effects in Bipolar Transistors." IEEE 1991, Bipolar Circuits and Technology Meeting 7.5, pp. 170-173.											
S.W.S.	S.R. Sheng, et al., "Degradati Stressing." pp. 14-15.	S.R. Sheng, et al., "Degradation and Recovery of SiGe HBTs Following Radiation and Hot-Carrier Stressing." pp. 14-15.											
LWL.		Z. Yang, et al., "Avalanche Current Induced Hot Carrier Degradation in 200 GHz SiGe Heterojunction Bipolar Transistors." pp. 1-5.											
SW.S,		H. Li, et al., "Design of W-Band VCOs with High Output Power for Potential Application in 77 GHz Automotive Radar Systems." 2003, IEEE GaAs Digest, pp. 263-66.											
S.W.S.		H. Wurzer, et al., "Annealing of Degraded nan-Transistors-Mechanisms and Modeling." IEEE Transactions on Electron Devices, vol. 41, no. 4, April 1994, pp. 533-38.											
S.W.S.		B. Doyle, et al., "Recovery of Hot-Carrier Damage in Reoxidized Nitrided Oxide MOSFETs." IEEE Electron Device Letters, vol. 13, no. 1, January 1992, pp. 38-40											
INS.		H.S. Momose, et al. "Analysis of the Temperature Dependence of Hot-Carrier-Induced Degradation in Bipolar Transistors for Bi-CMOS." IEEE Transactions on Electron Devices, vol. 41, no. 6, June 1994, pp. 978-987.											
J.W.J.	M. Khater, et al., "SiGe HE 2004 IEEE, 4 pages.	M. Khater, et al., "SiGe HBT Technology with Fmax/Ft = 350/300 GHz and Gate Delay Below 3.3 ps". 2004 IEEE, 4 pages.											
S.W.R.		J.C. Bean, et al., "GEx SI 1-x/Si Strained-Layer Superlattice Grown by Molecular Beam Epitaxy". J. Vac. Sci. Technol. A 2(2), AprJune 1984, pp. 436-440.											
LW, S,	J.H. Van Der Merwe, "Regul 117-122.	J.H. Van Der Merwe, "Regular Articles". Journal of Applied Physics, Volume 34, No. 1, January 1963, pp.											
IWS,	J.W. Matthews, et al., "Defec	J.W. Matthews, et al., "Defects in Epitaxial Multilayers". Journal of Crystal Growth 27 (1974), pp. 118-125.											
S.W.S.		Subramanian S. Iyer, et al. "Heterojuction Bipolar Transistors Using Si-Ge Alloys". IEEE Transactions on Electron Devices, Vol. 36, No. 10, October 1989, pp. 2043-2064											
J.W.J.		R.H.M. Van De Leur, et al., "Critical Thickness for Pseudomorphic Growth of Si/Ge Alloys and Superlattices". J. Appl. Phys. 64 (6), 15 September 1988, pp. 3043-3050											
I.W.Z.		D.C. Houghton, et al., "Equilibrium Critical Thickness for SI 1-x GEx Strained Layers on (100) Si". Appl. Phys. Lett. 56 (5), 29 January 1990, pp. 460-462											
SWS.	Q. Quyang et al., Two-Dimensional Bandgap Engineering in a Novel Si/SiGe pMOSFET with Enhanced Device Performance and Scalability", 2000, IEEE, pp. 151-154.												
EXAMINER SOMEW W. SMOD DATE CONSIDERED AUGUST 1, 2006													
*EXAMINER: Initial of citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant													